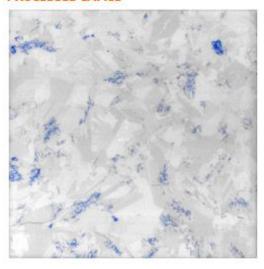
Wafer Report



PROCESSED IMAGE



GENERAL

Measured: 27/06/2014 11:09 AM

Operator: Jason Sample ID: 6823 Batch: Multi Demo Batch

RESULTS

Mean PL: 490 Lifetime: 1.430 Thickness: 180.617 Resistivity: 1.473

ANALYSIS

Recipe: multi default

Bin: 1 Grade: A1 Q: 0.626

IMPURE 0.00

DEFECTS 2,89

Wafer Report



PROCESSED IMAGE



GENERAL

Measured: 27/06/2014 10:33 AM

Operator: Jason Sample ID: 8525 Batch: Multi Demo Batch

RESULTS

Mean PL: 667 Lifetime: 1.437 Thickness: 185.981 Resistivity: 1.413

ANALYSIS

Recipe: multi default

Bin: 2 Grade: B1 Q: 0.875

IMPURE 11.63

DEFECTS 2.61